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Lateral heterostructures of WS₂ and MoS₂ monolayers for photo-synaptic transistor

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Von Neumann architecture-based computing, while widely successful in personal computers and embedded systems, faces inherent challenges including the von Neumann bottleneck, particularly amidst the ongoing surge of data-intensive tasks. Neuromorphic computing, designed to integrate arithmetic, logic, and memory operations, has emerged as a promising solution for improving energy efficiency and performance. This approach requires the construction of an artificial synaptic device that can simultaneously perform signal processing, learning, and memory operations. We present a photo-synaptic device with 32 analog multi-states by exploiting field-effect transistors based on the lateral heterostructures of two-dimensional (2D) WS₂ and MoS₂ monolayers, formed through a two-step metal-organic chemical vapor deposition process. These lateral heterostructures offer high photoresponsivity and enhanced efficiency of charge trapping at the interface between the heterostructures and SiO₂ due to the presence of the WS₂ monolayer with large trap densities. As a result, it enables the photo-synaptic transistor to implement synaptic behaviors of longterm plasticity and high recognition accuracy. To confirm the feasibility of the photo-synapse, we investigated its synaptic characteristics under optical and electrical stimuli, including the retention of excitatory post-synaptic currents, potentiation, habituation, nonlinearity factor, and paired-pulse facilitation. Our findings suggest the potential of versatile 2D material-synapse with a high density of device integration.

Keywords Lateral heterostructures, MoS₂, WS₂, Photo-transistors, Synaptic devices

As the third wave of artificial intelligence unfolds amidst the burgeoning volume of data and information to be processed, the pursuit of increased processing speed and a higher density of device integration has become critical requirements for information and communication technologies. The von Neumann architecture, a conventional computer architecture that segregates arithmetic/logic and memory operations, has been widely successful in personal computers and embedded systems. Its adoption has significantly contributed to the evolution of modern computing paradigms. However, this architecture often encounters significant challenges such as the von Neumann bottleneck (i.e., delay phenomenon) and limitations in enhancing the degree of device integration¹.

In contrast, the neuromorphic computing architecture, inspired by biological neural networks in the human brain and designed to seamlessly integrate arithmetic, logic, and memory operations, is considered a promising solution. This offers cost-effective and superior performance with advantages such as reduced power consumption, compact size, and high-speed processing^{2,3}. An artificial synaptic device serves as a basic building block of the neuromorphic system, emulating the essential functions of a biological synapse. Initially, non-volatile memories such as resistive random access memory^{4,5}, phase change memory⁶, and ferroelectric random access memory^{7,8} have been extensively studied as representative synaptic devices based on the two-terminal structure. However, two-terminal synaptic devices are limited in their ability to emulate biological synaptic functions because their structural limitations prevent them from simultaneously performing signal transmission and learning operations^{9–11}. Furthermore, they present substantial reliability challenges, especially in terms of retention and endurance.

On the other hand, three-terminal synaptic transistors, consisting of gate, source, and drain electrodes, have been developed to provide a higher degree of freedom in emulating synaptic behaviors. This advancement is achieved by leveraging an additional gate terminal, analogous to neurotransmitters, during the signal transmission process from a source terminal (i.e., pre-synaptic neuron) to a drain terminal (i.e., post-synaptic

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neuron)^{12–15}. Significant efforts have also been dedicated to investigating opto-electronic synaptic transistors as a means to implement artificial synapses that offer high speed, wide bandwidth, low power consumption, using input light stimuli^{13–17}.

Recently, advanced synaptic approaches have utilized the unique intrinsic physical properties of two-dimensional (2D) materials such as graphene, hexagonal boron nitride (h-BN), black phosphorus, and transition metal dichalcogenides $(TMDCs)^{18-28}$. These materials have garnered considerable attention due to their atomically thin layered structures, high carrier mobility, tunable electronic and optical properties, and charge storage capabilities, offering potential advantages in device miniaturization and integration¹⁸⁻³¹. In particular, TMDCs are employed in photo-synaptic transistors leveraging their photoresponsivity due to their strong light-matter interactions. However, the achievement of long-term plasticity in the synaptic functions faces challenges due to low trap densities and weak charge trapping^{18-25,32-34}. Therefore, refining the design and fabrication process, such as the insertion of the charge storage layer (e.g., SiN_x), has been proposed to more accurately mimic the potentiation and depression behaviors of synaptic connections by controlling charge movement within these layers^{20-25,32-34}.

In this study, we present a photo-synaptic device with analog multi-states of long-term plasticity and high recognition accuracy, derived from a 2D TMDC heteronanostructure-based field-effect transistor (FET). The approach involves exploiting the lateral heterostructures of 2D WS₂ and MoS₂ monolayer as a photoactive channel, which offers inherently high photoresponsivity while still maintaining reliable electrical properties^{29,30}. In the lateral heterojunction, the presence of the WS₂ monolayer with large trap densities results in enhanced efficiency of charge trapping at the interface between the WS₂/MoS₂ heterostructures and SiO₂ dielectric layer³¹. This enables the laterally-heterostructured WS₂/MoS₂-based photo-synaptic transistor (hereafter referred to as LHWM-synapse) to emulate the photo-synaptic functions. Under optical and electrical stimuli, synaptic characteristics, including retention of excitatory post-synaptic currents, potentiation, habituation, nonlinearity factor, and paired-pulse facilitation, were investigated to support the feasibility of LHWM-synapse. This advanced approach can extend their application potential across diverse fields, including neuromorphic computing, opto-electronic computing, intelligent sensing, human-machine interfaces, biomedical diagnostics, and wearables, enabling a new era in technology integration and applications³⁵⁻³⁷.

Results and discussion

To investigate the structural and optical properties of a laterally-heterostructured WS_2/MoS_2 monolayer, we characterized it using the MOCVD system (Fig. 1). The lateral heterostructures were grown using a two-step MOCVD process in a simple sequential way (Fig. 1a and Experimental Section). First, the MoS_2 monolayer was



Figure 1. Growth and characterization of MoS_2 and laterally-heterostructured WS_2/MoS_2 nanoflakes. (**a**) Schematic illustration of the growth of the WS_2/MoS_2 nanoflakes through a two-step sequential growth process. (**b**,**c**) Structural and optical properties of MoS_2 and WS_2/MoS_2 nanoflakes: (**b**) SEM images with a magnified view in the inset, (**c**) Raman spectra, and (**d**) PL spectra.

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grown on a SiO₂/Si substrate using H₂ ambient gas and excessive H₂S gas relative to the Mo(CO)₆ precursor^{38–43}. Then, the injection of the Mo(CO)₆ precursor was stopped while the flow of H₂S and H₂ gases was maintained under a working pressure of 40 Torr. After stabilization to purge the precursor and byproducts, the laterally-heterostructured WS₂/MoS₂ monolayer was grown as a monolayered WS₂ formed at the unpassivated edges of the MoS₂ monolayer by injecting the W(CO)₆ precursor in the second step^{38,43,44}. Top-view SEM images show that the MoS₂ monolayers and heterostructured WS₂/MoS₂ monolayers are formed with sharp triangular-shaped islands (Fig. 1b). The WS₂/MoS₂ exhibits a dark triangular center for MoS₂ and a bright outer edge for WS₂. This contrast is attributed to the higher atomic number of W in WS₂ compared to Mo in MoS₂.

The heterostructure formation and optical properties were confirmed by Raman and photoluminescence (PL) analyses. From the Raman spectra (Fig. 1c), single-structured MoS₂ monolayers showed two major Raman modes with the in-plane vibration (E_{2g}^1) at 386.33 cm⁻¹ and out-of-plane (A_{1g}) at 405.95 cm⁻¹ vibrations of S-Mo-S for MoS₂ (i.e., black rhombus). The heterostructured WS₂/MoS₂ monolayers showed two major Raman modes with the E_{2g}^1 at 355.35 cm⁻¹ and A_{1g} at 417.24 cm⁻¹ vibrations of S-W-S for WS₂ (i.e., blue circle) in addition to Raman modes for the MoS₂ monolayer. The frequency difference ($\Delta k = A_{1g} - E_{2g}^1$) between the two types of Raman vibration modes and the intensity ratio of the two peaks ($I_{E_{2g}^1}/I_{A_{1g}}$) were examined to estimate the number of layer for MoS₂ and WS₂⁴⁵⁻⁴⁷. As a result, the low Δk of 19.62 cm⁻¹ and 61.89 cm⁻¹ and high $I_{E_{2g}^1}/I_{A_{1g}}$ of 2.38 and 1.46 for MoS₂ and WS₂ support the formation of lateral heterostructures of MoS₂ and WS₂ monolayers. Furthermore, the laterally-heterostructured WS₂/MoS₂ monolayer indicates the full width at half maximum (FWHM) values of 6.32 (E_{2g}^1) and 6.85 (A_{1g}) for MoS₂ and 7.25 (E_{2g}^1) and 8.14 (A_{1g}) for WS₂, corresponding to high crystallinity⁴⁸.

From the PL spectra (Fig. 1d), single-structured MOS_2 showed one PL peak observed at 661 nm (1.88 eV) for MOS_2 (i.e., black rhombus). The laterally-heterostructured WS_2/MOS_2 show two different PL peaks at 628 nm (1.97 eV) and 661 nm (1.88 eV) for WS_2 (i.e., blue circle) and MOS_2 , respectively, resulting from a direct excitonic transition by the semiconducting behavior in the WS_2 and MOS_2 monolayers with 2H-phase^{49,50}. Since there is no PL quenching caused by the formation of the vertically heterostructure in the spectrum of WS_2/MOS_2 heterostructure, these results support that the lateral heterostructures of WS_2/MOS_2 monolayer are well-formed by a two-step process of simple sequential MOCVD growth.

To examine the feasibility of the lateral heterostructures of WS_2/MoS_2 monolayer as a photoactive channel, we fabricated a back-gated FET using a conventional lithography and metal deposition process (Experimental Section). The electrical properties of the laterally-heterostructured WS_2/MoS_2 -based FET (hereafter referred to as LHWM-FET) were investigated for a photo-synapse (Fig. 2). In the dark condition, the output characteristic of the LHWM-FET exhibits the Ohmic and n-type behaviors between WS_2/MoS_2 channel and Au/Ti electrodes (Figure S1a). In the dark and light illumination, the transfer characteristics were explored in a logarithmic scale, where the drain-source current (I_{DS}) is plotted as a function of the gate voltage (V_G) at the source-drain voltage (V_{DS}) of +1 V (Fig. 2b).

The I_{DS} - V_G transfer characteristic in dark condition shows that the LHWM-FET has n-type and clockwise hysteresis behaviors that originated from the carrier traps (Figure S1b). From the I_{DS} - V_G transfer characteristic of the LHWM-FET, the ratio of maximum I_{DS} to minimum I_{DS} (on/off ratio) of \sim 10⁴, threshold voltage (V_{TH}) of – 19.45 V, and sub-threshold swing (SS) of 10.25 V/dec were calculated (Experimental Section). From the hysteresis behavior, the density of trapped charges (N_{trap}) at the WS₂/MoS₂ and SiO₂ interface is calculated using the following equation:

$$N_{trap} = \frac{C_{oxide} * \Delta V_{TH}}{q} = \frac{C_{oxide} * |V_{TH}(forward) - V_{TH}(reverse)|}{q}$$
(1)

where C_{oxide} is the capacitance of the SiO₂ back-gated oxide, V_{TH} is the threshold voltage obtained from the forward and reverse sweeps, and q is the quantity of electric charge. For a V_G swing of ± 30 V, the N_{trap} for the LHWM-synapse is obtained to be 5.44×10^{12} cm⁻². Compared to the MoS₂-based FET (Fig. S2), the negatively shifted V_{TH} , higher SS, and larger trap density in the LHWM-FET are attributed to increased trap densities.

The opto-electronic characteristics of the LHWM-FET with the intrinsic photoresponsivity are investigated under the light illumination of 532 nm and 635 nm wavelength. Under light illumination, a negative shift in the V_{TH} and an increase of I_{DS} originate from the photo-generated carriers in the LHWM photoactive channel. After turning off the light illumination, the transfer curves of the LHWM-FET shifted in the negative direction under illumination of 532 nm and 635 nm wavelengths, and slowly returned to their initial state (i.e., dark condition) over time. In 635 nm light illumination, the initial dark state was reached in 360 s, and a long time of more than 780 s was required to return to the initial dark state in 532 nm light illumination. The negative shifted transfer characteristic, which is still observed when the lights are turned off, implies that recombination is suppressed even after the light was turned off by trapping the photo-generated carriers at the interface of the gate oxide and the semiconductor channel. In contrast, the transfer characteristics of the MoS₂-FET returned to their initial state immediately after turning off the light illumination (Fig. S2). This is consistent with previous studies in which MoS₂-FET responses to light illumination but quickly recovers to its initial state (i.e., volatile), making it difficult to implement long-term plasticity of the synaptic fuctions²⁰. It indicates that the improved carrier trapping of the LHWM-FET is related to the WS₂ layer. From these results, the presence of WS₂ in the WS₂/MoS₂ lateral heterostructures supports that it may implement the photo-synaptic transistor with long-term plasticity by enhancing carrier trapping.

To further understand the photo-synaptic behavior of the LHWM-FET, we investigated the mechanisms of charge trapping and de-trapping under dark and 532 nm light illumination conditions using time-resolved I_{DS} measurements (Figs. 3 and S3)⁵¹⁻⁵⁵. The energy band diagram, including the bandgap energy (E_{ν}), the conduction



Figure 2. Device structure and transfer characteristics of the WS_2/MoS_2 -based back-gated FET. (a) Schematic illustration of back-gated WS_2/MoS_2 -based photo-transistor. Transfer characteristics with a wavelength of (b) 635 nm and (c) 532 nm.

band (E_c), the valence band (E_v), and the electron affinity (χ), was characterized using multi-dielectric energy band diagram software and PL responses, as supported by references^{51–55}. The measurements were taken for 120 s at V_{DS} of +1 V, V_G of + 30 V and – 30 V. Positive gate bias resulted in the gradual decrease of I_{DS} by trapping electrons from the WS₂/MoS₂ channel into the interface trap sites, leading to a decrease in the n-type characteristic (Figs. 3a and S3a,b). In contrast, the negative gate bias enhanced the n-type characteristic by releasing electrons from the interface trap sites into the WS₂/MoS₂ channel, resulting in a gradual increase of I_{DS} (Figs. 3a and S3c,d). Interestingly, the photo-generated holes were trapped at the interface by the negative gate bias, which in turn contribute to the conductance of the LHWM-FET, resulting in a significant increase in I_{DS} under light illumination (Figs. 3b and S3d).

To confirm the photo-synaptic behaviors, we investigated the conductivity variation of the LHWM-FET by applying a 2-s single pulse of 532 nm and 635 nm at $V_G = -30$ V and $V_{DS} = +1$ V (Fig. 4). For the MoS₂-FET, the triggered photocurrents by a single light pulse rapidly returned to their initial sate as soon as the light pulse was turned off (Fig. S4). On the other hand, when applying the single light pulse, the LHWM-FET showed excitatory post-synaptic currents (EPSCs) that did not return to the initial state immediately. It is attributed that the type-II heterojunction of WS₂ and MoS₂ results in the photo-generated holes transferring to WS₂, which enhances charge trapping generated at the WS₂ and SiO₂ interface (Fig. 3b,c). With the unique optical properties of the LHWM monolayer, the two different wavelengths may trigger different synaptic characteristics and thus exhibit the potential to implement multi-wavelength optoelectronic synapse.

To emulate the artificial synaptic characteristics of the LHWM-synapse, the effects of opto-electronic stimulation were investigated at the 532 nm light pulse under V_G of – 30 V and V_{DS} of + 1 V with 0.5 Hz repetition frequency (Fig. 5). First, the triggered EPSC of LHWM-synapse by an applied pre-synaptic light spike exhibited the retainable photocurrent for 570 s, representing that the trapped charge is remembered for the long term (Figs. 5a and S5a). Synaptic plasticity characteristics of the LHWM-synapse were further investigated by the rehearsal process. The analog multi-states of the long-term plasticity characteristic with linearity were observed by applying 32 consecutive light pulses with 0.5 Hz repetition frequency and 50% duty cycle (Fig. 5b,c). With 32 light pulse trains, the time-resolved I_{DS} is retainable due to the non-volatile charge trapping, indicating long-term potentiation behavior (Figs. 5b and S5b).

In contrast, for the MoS_2 -based synapse, the EPSC triggered by a single pulse not only returned quickly to the initial state, but also exhibited short-term plasticity characteristics with nonlinearity in 32 consecutive light pulses (Fig. S5c,d). The LHWM-synapse was potentiated by applying 32 consecutive light pulses of 532 nm wavelength at a constant V_G of -30 V and V_{DS} of +1 V with a 0.5 Hz repetition frequency (Fig. 5c). The analog multi-states



Figure 3. Energy band diagram and schematic illustration of WS_2/MoS_2 -based photo-transistor for a synaptic device. (a) Energy band diagram of the WS_2/MoS_2 photo-transistor at different biases. (b) Schematic illustration of the WS_2/MoS_2 photo-transistor at the WS_2/MoS_2 and SiO_2 interface with negative gate bias under 532 nm light illumination. (c) Band structures for the WS_2 and MoS_2 heterojunction under 532 nm light illumination.

which implement LTP characteristics in the synaptic device require linear behavior to ensure high recognition accuracy. With 32 light pulse trains, the photonic potentiation process shows an increase of the EPSC gradually from 125 pA to 1.25 nA, and the 32 analog states have good linearity. In 32 analog multi-states, the EPSC ratio triggered by the 1st pulse and 32nd pulse is 9.97. The non-linearity factor of LHWM-synapse is extracted from the potentiation behavior:

$$I_{LTP} = I_{min} + I_o * (1 - e^{-\nu x})$$
⁽²⁾

where I_{min} is minimum current, x is the number of pulse, I_o is the fitting parameter, and v is the non-linearity factor. The non-linearity factor of LTP behavior for the LHWM-synapse is obtained to be 0.06. In the LTP behavior of LHWM-synapse, the good linearity of 32 conduction states may implement 5-bit memory with high recognition accuracy by the photonic potentiation. The response to the stimulus in the LHWM-synapse is characterized by a depression effect, induced by applying 32 electrical pulses with a V_G amplitude of + 15 V and a constant V_{DS} of + 1 V. Each pulse had a duration of 8 s, interspersed with intervals of 2 s, under dark conditions. Electrical stimulus implemented gradual long-term depression (LTD) behavior of the LHWM-synapse. The non-linearity factor of LHWM-synapse is extracted from the depression behavior:

$$I_{LTD} = I_{max} - I_o * (1 - e^{-\nu(x - 32)})$$
(3)

where I_{max} is maximum current, x is the number of pulse, I_o is the fitting parameter, and v is the non-linearity factor. The non-linearity factor of LTD behavior for the LHWM-synapse is obtained to be 0.18. With the electrical stimulus, the LHWM-synapse implemented 32-LTD behavior for 5-bit memory.



Figure 4. Photo-response behaviors of WS₂/MoS₂ heterostructure-based photo-transistor under illumination with different wavelength of 532 nm (green) and 635 nm (red). Source-drain currents (I_{DS}) with respect to time of the photo-transistor illuminated by a single light pulse of 2 s at $V_G = -30$ V and $V_{DS} = +1$ V. After a single light pulse of 532 nm and 635 nm, the current does not return to its initial state within 120 s.



Figure 5. Characteristics of the LHWM-synapse at $V_G = -30 \text{ V}$, $V_{DS} = +1 \text{ V}$, and a light pulse with a wavelength of 532 nm. (a) Excitatory post-synaptic current (EPSC) triggered by a single light pulse of 2 s. (b) EPSC triggered by 32 light pulses with an applied pulse width of 2 s and a time interval of 2 s. (c) The variation of I_{DS} versus the pulse trains. Potentiation and habituation processes were implemented by applying light pulses (photonic potentiation) and electrical pulses (electric habituation), respectively. (d) Paired-pulse facilitation (PPF) index $[(A_2-A_1)/A_1]$ as a function of pulse interval time (Δt) for the pulse width of 2 s.

The paired-pulse facilitation (PPF) characteristic of the LHWM-synapse (Fig. 5d), where the second presynaptic spike caused a larger post-synaptic current than the first pre-synaptic spike, was investigated at the light pulse width of 2 s:

$$PPF = \frac{A_2 - A_1}{A_1} \tag{4}$$

where A_1 and A_2 are the amplitudes of the first EPSC and second EPSC, respectively. The maximum PPF index of the LHWM-synapse was 45.2% for a 1 s time interval between two consecutive light pulses. As the Δt time interval increased from 1 to 64 s, the PPF index gradually decreased from 45.2% to 7.9%. The relationship between Δt and PPF index was fitted by the double-exponential function:

$$PPF = 1 + A_1 * exp(-\Delta t/\tau_1) + A_2 * exp(-\Delta t/\tau_2)$$
(5)

where A_1 and A_2 are the initial facilitation magnitudes, and τ_1 and τ_2 are the characteristic relaxation times. For the pulse width of 2 s, the derived relaxation times were found to be $\tau_1 = 0.97$ s and $\tau_2 = 25.3$ s, which are consistent with the response of a biological synapse.

Conclusion

In conclusion, we have identified the potential of heteronanostructures of WS₂/MoS₂ monolayer as promising candidates for artificial photo-synaptic devices with long-term plasticity and 5-bit memory. By utilizing the inherently high photoresponsivity and enhanced charge trapping capability of these structures, we successfully emulated photo-synaptic behaviors. To investigate the applicability of the LHWM-synapse, we applied both optical and electrical stimuli, and examined various synaptic properties such as the retention of excitatory post-synaptic currents, potentiation, habituation, nonlinearity factor, and paired-pulse facilitation. These results suggest that lateral heterojunctions in 2D material-based synapse could provide a simple and scalable nanomanufacturing method for achieving analog multi-states with long-term plasticity and high learning accuracy. While further research is required to refine synaptic weights by reducing pulse width and applied voltage, and to explore different wavelengths for the practical implementation of versatile photo-synapses, our findings indicate the potential of 2D material-based photo-synapses as a pioneering approach. These devices are at the forefront of not only enabling next-generation neuromorphic and optoelectronic computing systems but also expanding their reach into fields such as intelligent sensing, advanced human-machine interfaces, precise biomedical diagnostics, and innovative wearables.

Experimental section

Materials Mo(CO)₆ (\geq 99.9%) and W(CO)₆ (\geq 99.99%) were purchased from Sigma-Aldrich Co., USA. H₂S (99.9%) gas was purchased from Noblegas Co., Republic of Korea. H₂ (99.999%) and Ar (99.999%) gases were purchased from Samogas Co., Republic of Korea. Polymethyl methacrylate (PMMA) was purchased from Micro-Chem Co., USA. Methyl isobutyl ketone (MIBK) was purchased from Kayaku Co., Japan. Isopropyl alcohol (IPA) and acetone solvents were purchased from Duksan Pure Chemicals Co., Republic of Korea. A p-type Si wafer with a 300-nm thick SiO₂ layer (SiO₂/Si, <0.005 Ω cm) was purchased from iTASCO Co., Republic of Korea.

Growth of laterally-heterostructured WS_2/MoS_2 monolayer The laterally-heterostructured WS_2/MoS_2 (LHWM) monolayer was grown on a SiO₂/Si wafer using a metal–organic chemical vapor deposition (MOCVD) system with a shower-head-type reactor. The substrate was loaded into a MOCVD chamber at a temperature of 400 °C. A large amount of H₂ (600 sccm) and H₂S (600 sccm) gases were injected into the process chamber, and the working pressure was controlled to be 40 Torr to facilitate the 2D lateral growth of the WS₂/MoS₂ heterostructure. To regulate the flow rate of Mo(CO)₆ and W(CO)₆ precursors, a circulation chiller system (set at 2 °C) connected to precursor canisters was used with a carrier gas of 0.3 sccm Ar. Firstly, the MoS₂ monolayer was grown under a working pressure of 40 Torr and a temperature of 400 °C for 2 h. A two-step process of simple sequential MOCVD was used to form the LHWM monolayer. After the growth of the MoS₂ monolayer, the flow of the Mo(CO)₆ precursor was terminated, and the injection of H₂S and H₂ gases into the working chamber was maintained for 1 h at a pressure of 40 Torr. This stabilization process, which involved purging precursor and byproducts, was carried out for 1 h. Then, the second W(CO)₆ precursor was injected to grow WS₂ thin films. The LHWM monolayer was formed by the lateral growth of WS₂ at the edge of the MoS₂ monolayer.

Fabrication of the field-effect transistor (FET) for a photo-synaptic device A back-gated FET based on the LHWM monolayer was fabricated using the e-beam lithography method. First, the PMMA 950 C4 e-beam resist was spin-coated on the WS₂/MoS₂ monolayer at 500 rpm for 5 s and 5000 rpm for 40 s. The spin-coated sample was baked at 180 °C for 90 s. The ER layer was patterned with an area dose of 300 μ C cm⁻² at 30 keV exposure using a field-emission scanning electron microscopy (SEM) system (FEI Sirion 400, Czech). The LHWM-based FET device has a line width of 2 μ m and a spacing of 300 nm. Then, the e-beam exposed sample was developed in a mixture solution of MIBK/IPA (1:3 volume concentration ratio) for 30 s. A 100 nm Au/10 nm Ti film was deposited for the source and drain electrodes at a working pressure of ~ 10⁻⁸ Torr and a deposition rate of ~ 0.2 Å/s by an e-beam evaporator system (IVT, Republic of Korea). To peel off the metal film on the ER layer, a lift-off process was carried out with an acetone solvent for 24 h. Then, the sample was rinsed in fresh acetone and IPA, and was blow-dried with N₂ gas. As a result, an LHWM-back-gated FET was prepared for use a photo-synaptic transistor.

Characterization The structural and morphological properties were characterized by field-emission SEM at accelerating voltages of 10 kV (Hitachi S-4800, Japan) and 1 kV (Zeiss Sigma 300 VP, Germany). Raman and photoluminescence (PL) were measured using a confocal Raman spectroscopy (Renishaw inVia, UK) system with

a 488 nm laser of 100 μ W power. The electrical properties of the FETs were characterized using a measurement system consisting of a semiconductor parameter analyzer (Keysight HP 4156A, USA) with a pulse generator (Keysight HP 41501, USA) and a probe station (Cascade Microtech Alessi REL-5500, USA). In electrical characterization, the on/off current ratio is calculated as the ratio of maximum I_{DS} to minimum I_{DS}. The threshold voltage (V_{TH}) is estimated as the linear region extrapolation of the slope of I_{DS}^{0.5} versus V_G curve, and the sub-threshold swing (SS) is defined as the inverse of the slope of the log I_{DS} versus V_G curve.

Data availability

All data generated or analysed during this study are included in this published article (and its Supplementary Information files).

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References

- 1. Merolla, P. A. *et al.* A million spiking-neuron integrated circuit with a scalable communication network and interface. *Science* **345**(6197), 668–673 (2014).
- Indiveri, G., Linares-Barranco, B., Legenstein, R., Deligeorgis, G. & Prodromakis, T. Integration of nanoscale memristor synapses in neuromorphic computing architectures. *Nanotechnology* 24(38), 384010 (2013).
- 3. Mead, C. Neuromorphic electronic systems. Proc. IEEE 78(10), 1629–1636 (1990).
- 4. Jo, S. H. et al. Nanoscale memristor device as synapse in neuromorphic systems. Nano Lett. 10(4), 1297–1301 (2010).
- Yu, S., Wu, Y., Jeyasingh, R., Kuzum, D. & Wong, H.-S.P. An electronic synapse device based on metal oxide resistive switching memory for neuromorphic computation. *IEEE Trans. Electron Devices* 58(8), 2729–2737 (2011).
- Kuzum, D., Jeyasingh, R. G., Lee, B. & Wong, H.-S.P. Nanoelectronic programmable synapses based on phase change materials for brain-inspired computing. *Nano Lett.* 12(5), 2179–2186 (2012).
- Jerry, M., Chen, P.-Y., Zhang, J., Sharma, P., Ni, K., Yu, S. & Datta, S. Ferroelectric FET analog synapse for acceleration of deep neural network training. In 2017 IEEE International Electron Devices Meeting (IEDM) 6.2. 1–6.2. 4 (IEEE, 2017).
- 8. Jerry, M. et al. A ferroelectric field effect transistor based synaptic weight cell. J. Phys. D Appl. Phys. 51(43), 434001 (2018).
- 9. Avizienis, A. V., Sillin, H. O., Martin-Olmos, C., Shieh, H. H., Aono, M., Stieg, A. Z. & Gimzewski, J. K. Neuromorphic atomic switch networks (2012).
- 10. Pyo, J., Bae, J.-H., Kim, S. & Cho, S. Short-term memory characteristics of IGZO-based three-terminal devices. *Materials* 16(3), 1249 (2023).
- 11. Han, H., Yu, H., Wei, H., Gong, J. & Xu, W. Recent progress in three-terminal artificial synapses: From device to system. *Small* 15(32), 1900695 (2019).
- 12. Alibart, F. *et al.* An organic nanoparticle transistor behaving as a biological spiking synapse. *Adv. Funct. Mater.* **20**(2), 330–337 (2010).
- 13. Sun, C. et al. Single-chip microprocessor that communicates directly using light. Nature 528(7583), 534-538 (2015).
- Kim, J., Lim, J. W. & Lee, J. Characteristics of PEALD-Hafnium dioxide films and their application to gate insulator stacks of photosynaptic transistors. Adv. Electron. Mater. 8(4), 2101061 (2022).
- Lim, J. W., Park, M. A. & Kim, J. Photo-synaptic oxide transistors with Al₂O₃/SiO_x stacked gate dielectric exhibiting 1024 conduction states with good linearity. *Adv. Electron. Mater.* 8(10), 2200494 (2022).
- Kim, M.-K., Kim, I.-J. & Lee, J.-S. Oxide semiconductor-based ferroelectric thin-film transistors for advanced neuromorphic computing. Appl. Phys. Lett. 118(3), 032902 (2021).
- 17. Kim, S. et al. Ferroelectric polymer-based artificial synapse for neuromorphic computing. Nanoscale Horiz. 6(2), 139-147 (2021).
- Islam, M. M., Dev, D., Krishnaprasad, A., Tetard, L. & Roy, T. Optoelectronic synapse using monolayer MoS₂ field effect transistors. Sci. Rep. 10(1), 1–9 (2020).
- Kim, S.-G. *et al.* Infrared detectable MoS₂ phototransistor and its application to artificial multilevel optic-neural synapse. ACS Nano 13(9), 10294–10300 (2019).
- Xu, M. *et al.* Optoelectronic synapses based on photo-induced doping in MoS₂/h-BN field-effect transistors. *Adv. Opt. Mater.* 9(20), 2100937 (2021).
- Wang, I.-T., Chang, C.-C., Chen, Y.-Y., Su, Y.-S. & Hou, T.-H. Two-dimensional materials for artificial synapses: Toward a practical application. *Neuromorphic Comput. Eng.* 2, 012003 (2022).
- 22. Zhang, Z. et al. 2D materials and van der Waals heterojunctions for neuromorphic computing. Neuromorphic Comput. Eng. 2, 032004 (2022).
- Chen, Y.-Y., Hsu, C. -P., Liu, P. -S. & Hou, T. -H. Two-dimensional Layered Materials for Artificial Synapse. In 2020 International Symposium on VLSI Technology, Systems and Applications (VLSI-TSA) 141–142 (IEEE, 2020).
- He, C. et al. Artificial synapse based on van der Waals heterostructures with tunable synaptic functions for neuromorphic computing. ACS Appl. Mater. Interface 12(10), 11945–11954 (2020).
- Xiang, D., Liu, T., Zhang, X., Zhou, P. & Chen, W. Dielectric engineered two-dimensional neuromorphic transistors. *Nano Lett.* 21(8), 3557–3565 (2021).
- Schranghamer, T. F., Oberoi, A. & Das, S. Graphene memristive synapses for high precision neuromorphic computing. Nat. Comm. 11(1), 5474 (2020).
- 27. Tian, H. et al. Anisotropic black phosphorus synaptic device for neuromorphic applications. Adv. Mater. 28(25), 4991–4997 (2016).
- 28. Tian, H. et al. Graphene dynamic synapse with modulatable plasticity. Nano Lett. 15(12), 8013-8019 (2015)
- 29. Park, J. et al. Heteronanostructured Field-effect transistors for enhancing entropy and parameter space in electrical unclonable primitives. ACS Nano 18(1), 1041–1053 (2023).
- Huo, N. J. et al. Novel and enhanced optoelectronic performances of multilayer MoS₂–WS₂ heterostructure transistors. Adv. Funct. Mater. 24(44), 7025–7031 (2014).
- Sebastian, A., Pendurthi, R., Choudhury, T. H., Redwing, J. M. & Das, S. Benchmarking monolayer MoS₂ and WS₂ field-effect transistors. *Nat. Comm.* 12(1), 693 (2021).
- 32. He, H.-K. *et al.* Multi-gate memristive synapses realized with the lateral heterostructure of 2D WSe₂ and WO₃. *Nanoscale* **12**(1), 380–387 (2020).
- 33. Seo, S. et al. Artificial optic-neural synapse for colored and color-mixed pattern recognition. Nat. Comm. 9(1), 5106 (2018).
- Wang, S. et al. A MoS2/PTCDA hybrid heterojunction synapse with efficient photoelectric dual modulation and versatility. Adv. Mater. 31(3), 1806227 (2019).
- Patil, R. & Dutta, S. Intercalation engineering of 2D materials at macroscale for smart human–machine interface and double-layer to faradaic charge storage for ions separation. Adv. Mater. Interfaces 10(7), 2202137 (2023).

- Ranasinghe, J. C. et al. Engineered 2D materials for optical bioimaging and path toward therapy and tissue engineering. J. Mater. Res. 37(10), 1689–1713 (2022).
- Oh, S., Lee, J.-J., Seo, S., Yoo, G. & Park, J.-H. Photoelectroactive artificial synapse and its application to biosignal pattern recognition. npj 2D Mater. Appl. 5(1), 95 (2021).
- Kang, K. et al. High-mobility three-atom-thick semiconducting films with wafer-scale homogeneity. Nature 520(7549), 656–660 (2015).
- Kim, T. et al. Wafer-scale production of highly uniform two-dimensional MoS₂ by metal-organic chemical vapor deposition. Nanotechnology 28(18), 18LT01 (2017).
- Sheng, Y., Tan, H., Wang, X. & Warner, J. H. Hydrogen addition for centimeter-sized monolayer tungsten disulfide continuous films by ambient pressure chemical vapor deposition. *Chem. Mater.* 29(11), 4904–4911 (2017).
- McCreary, K. M., Hanbicki, A. T., Jernigan, G. G., Culbertson, J. C. & Jonker, B. T. Synthesis of large-area WS₂ monolayers with exceptional photoluminescence. Sci. Rep. 6(1), 1–7 (2016).
- Ji, H. G. et al. Hydrogen-assisted epitaxial growth of monolayer tungsten disulfide and seamless grain stitching. Chem. Mater. 30(2), 403-411 (2018).
- Yoo, Y. D., Degregorio, Z. P. & Johns, J. E. Seed crystal homogeneity controls lateral and vertical heteroepitaxy of monolayer MoS₂ and WS₂. J. Am. Chem. Soc. 137(45), 14281–14287 (2015).
- 44. Mun, J. et al. Low-temperature growth of layered molybdenum disulphide with controlled clusters. Sci. Rep. 6(1), 1-7 (2016).
- 45. Berkdemir, A. et al. Identification of individual and few layers of WS₂ using Raman Spectroscopy. Sci. Rep. **3**, 1755 (2013).
- 46. Lee, C. et al. Anomalous lattice vibrations of single-and few-layer MoS₂. ACS Nano 4(5), 2695–2700 (2010).
- 47. Li, H. *et al.* From bulk to monolayer MoS₂: Evolution of Raman scattering. *Adv. Funct. Mater.* **22**(7), 1385–1390 (2012).
- Sahoo, S., Gaur, A. P. S., Ahmadi, M., Guinel, M. J. F. & Katiyar, R. S. Temperature-dependent raman studies and thermal conductivity of few-layer MoS₂. J. Phys. Chem. C 117(17), 9042–9047 (2013).
- 49. Gutierrez, H. R. *et al.* Extraordinary room-temperature photoluminescence in triangular WS₂ monolayers. *Nano Lett.* **13**(8), 3447–3454 (2013).
- Mak, K. F., Lee, C., Hone, J., Shan, J. & Heinz, T. F. Atomically thin MoS₂: A new direct-gap semiconductor. *Phys. Rev. Lett.* 105(13), 136805 (2010).
- Roy, S. & Bermel, P. Electronic and optical properties of ultra-thin 2D tungsten disulfide for photovoltaic applications. *Sol. Energy Mater. Sol. Cells* 174, 370–379 (2018).
- Kumar, A. & Ahluwalia, P. Tunable dielectric response of transition metals dichalcogenides MX₂ (M= Mo, W; X= S, Se, Te): Effect of quantum confinement. *Phys. B Condens. Matter.* 407(24), 4627–4634 (2012).
- Xie, Y. et al. Defect engineering of MoS₂ for room-temperature terahertz photodetection. ACS Appl. Mater. Interface 12(6), 7351– 7357 (2020).
- 54. Li, Y. *et al.* Measurement of the optical dielectric function of monolayer transition-metal dichalcogenides: MoS₂, MoSe₂, WS₂, and WSe₂. *Phys. Rev. B* **90**(20), 205422 (2014).
- Howell, S. L. et al. Investigation of band-offsets at monolayer-multilayer MoS₂ junctions by scanning photocurrent microscopy. Nano Lett. 15(4), 2278–2284 (2015).

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Author contributions

J.P. synthesized the LHWM monolayer. J.P. and J.O.K. fabricated and measured the LHWM-synapse. J.P. and J.O.K. analysed the results and wrote the manuscript. S.-W.K. reviewed and supervised the work.

Competing interests

The authors declare no competing interests.

Additional information

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